[54]	REFRACTORY SURFACES FOR ALUMINA
	REDUCTION CELL CATHODES AND
	METHODS FOR PROVIDING SUCH
	SURFACES

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Richmond, Va.

[21] Appl. No.: 43,242

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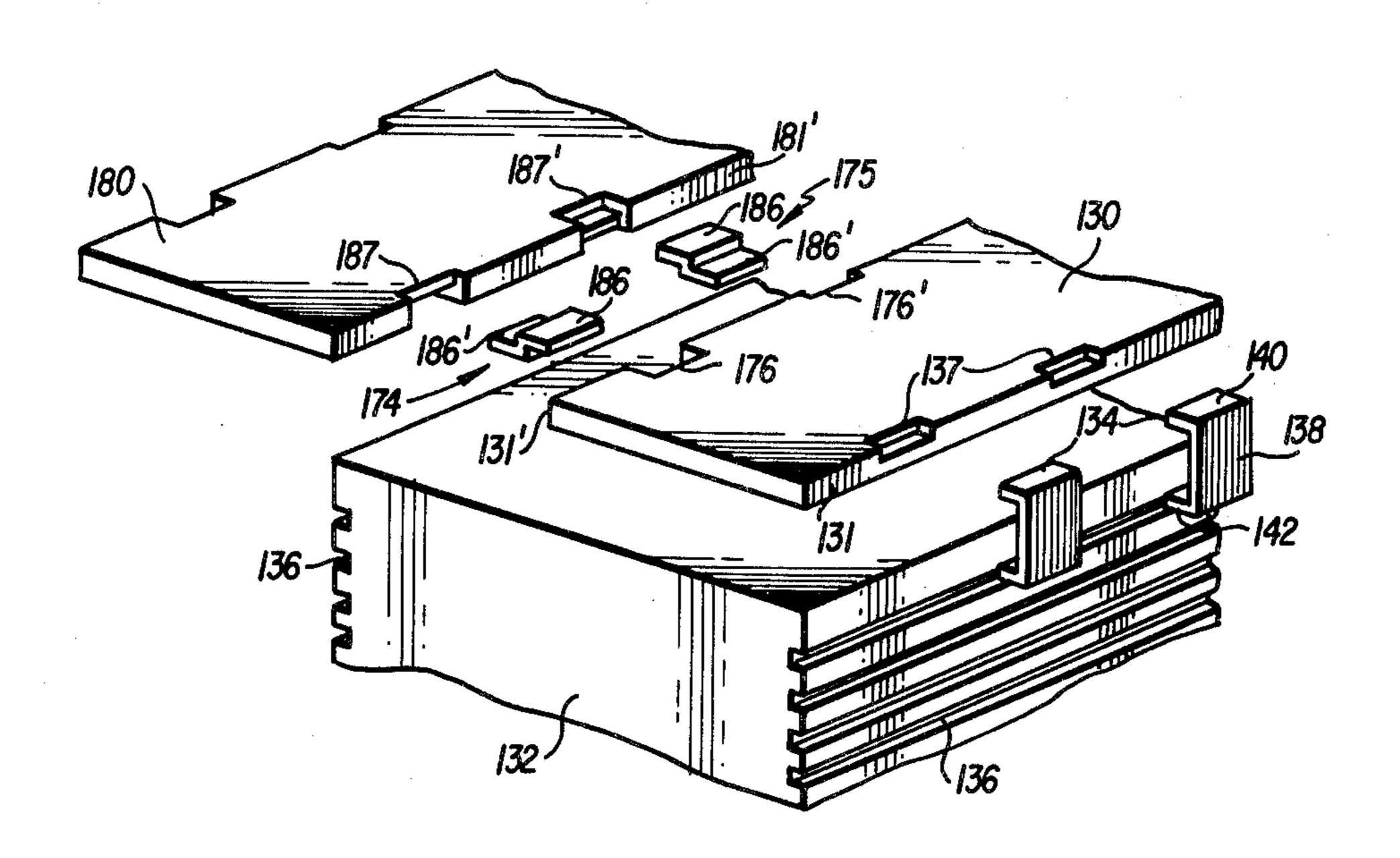
[57] ABSTRACT

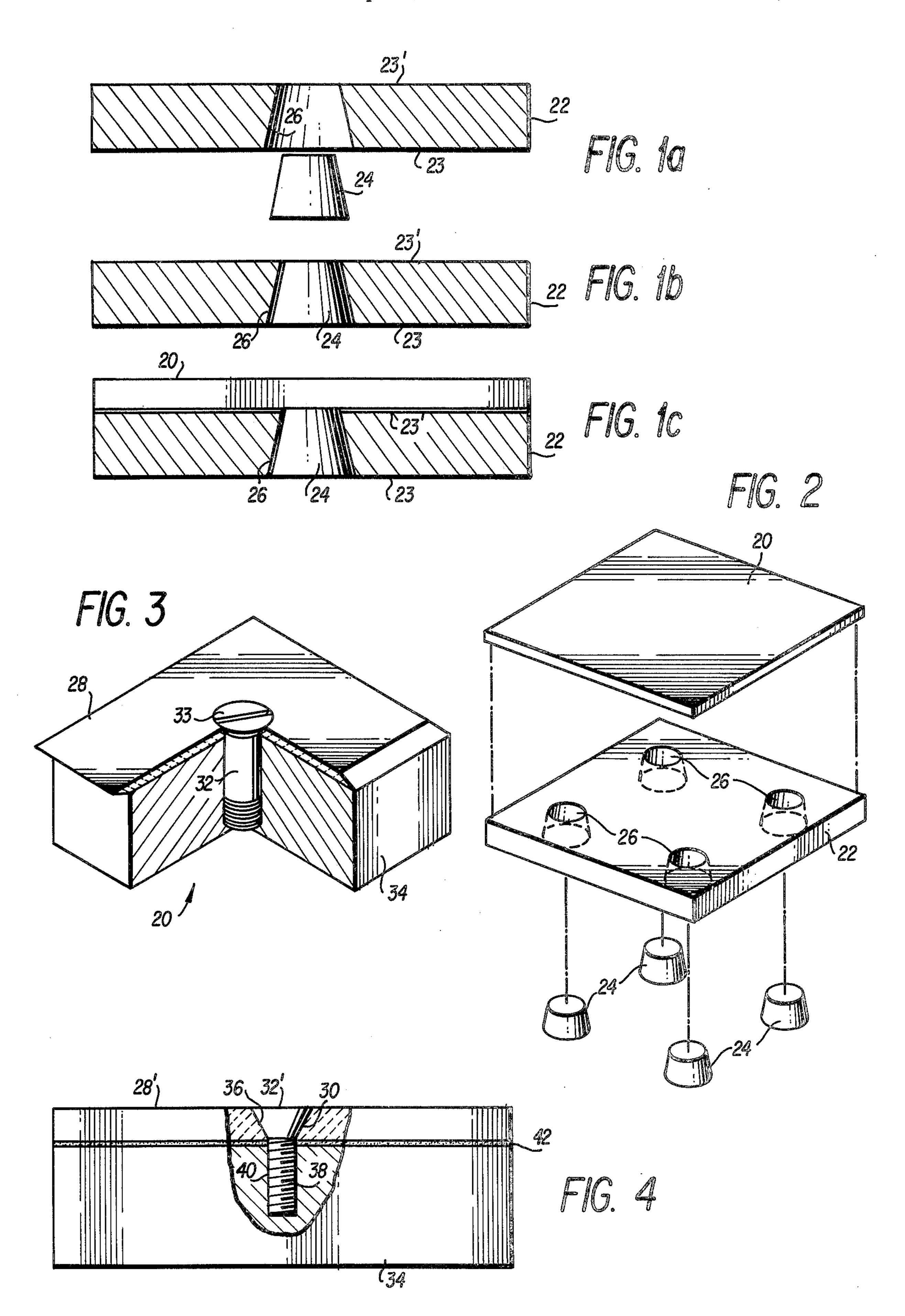
The disclosure pertains to alumina reduction cells which employ refractory materials to provide a molten-aluminum contacting surface for the cathode. Specifi-

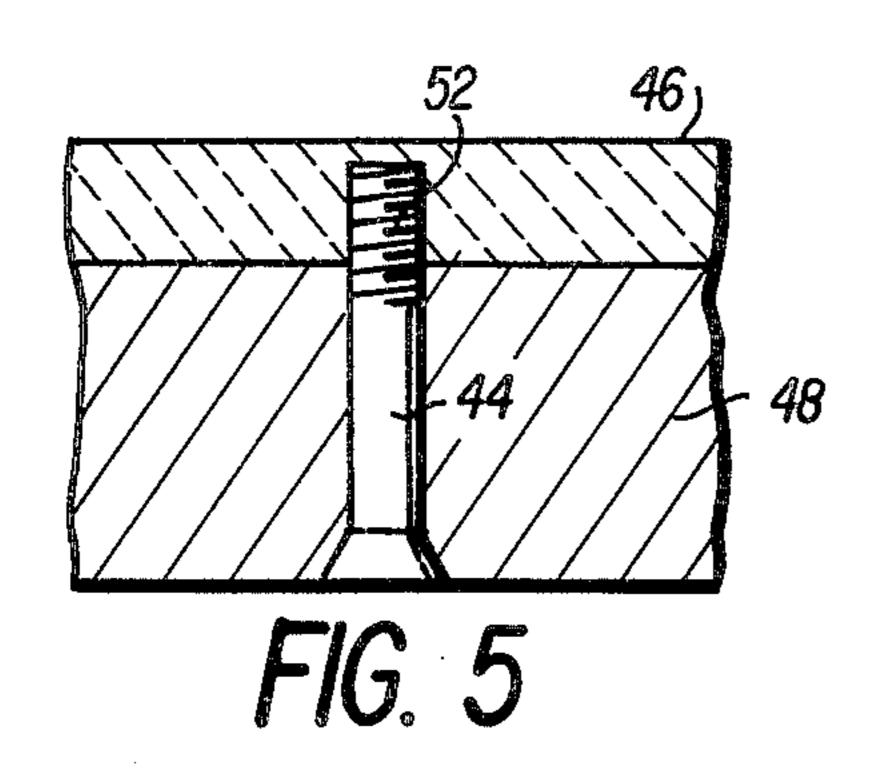
cally, configurations and methods are described according to which refractory hard metal tiles are secured to a carbonaceous substrate to produce composites suitable for constructing a molten-aluminum contacting surface for the use stated. The tiles are wettable by molten aluminum and are inert chemically to the reduction cell electrolyte. Configurations for coupling and interlocking such tiles are also described. When the tiles are coupled or interlocked in the manner taught, it is possible to achieve a built-up refractory surface which remains chemically and mechanically stable in a reduction cell environment. The refractory hard metal materials used are included among the borides, nitrides and carbides of Group IV, V, and VI of the Periodic System, particularly compounds of titanium and zirconium, and especially titanium-diboride and titanium-diboride aluminum-nitride mixtures.

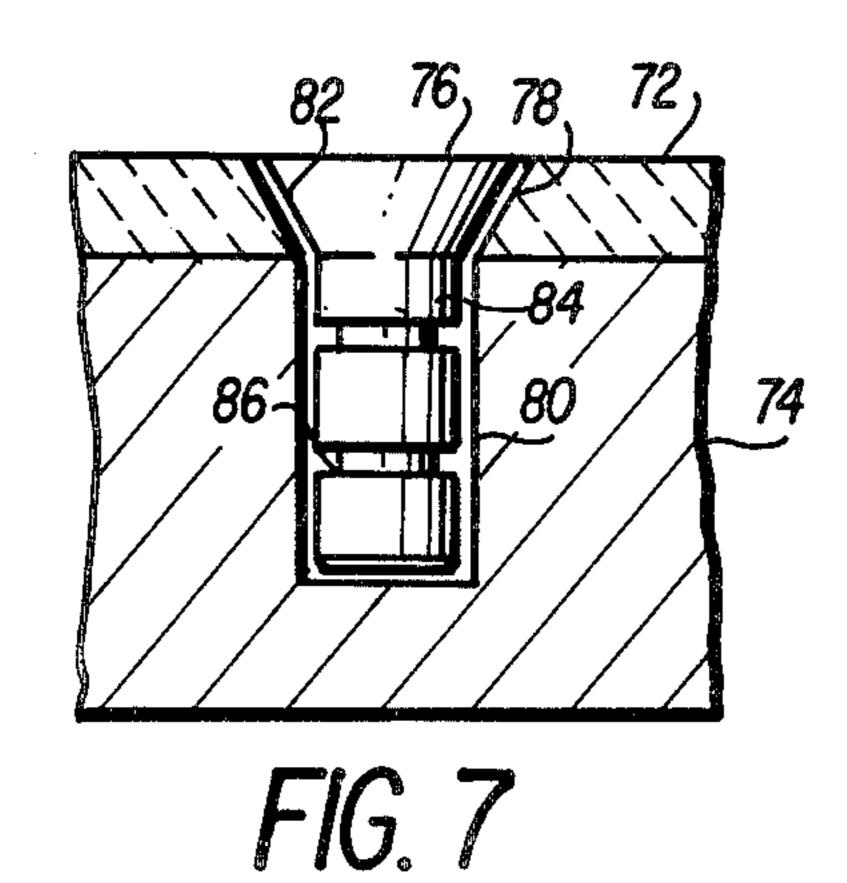
53 Claims, 3 Sheets Drawing,51 Pages Specification

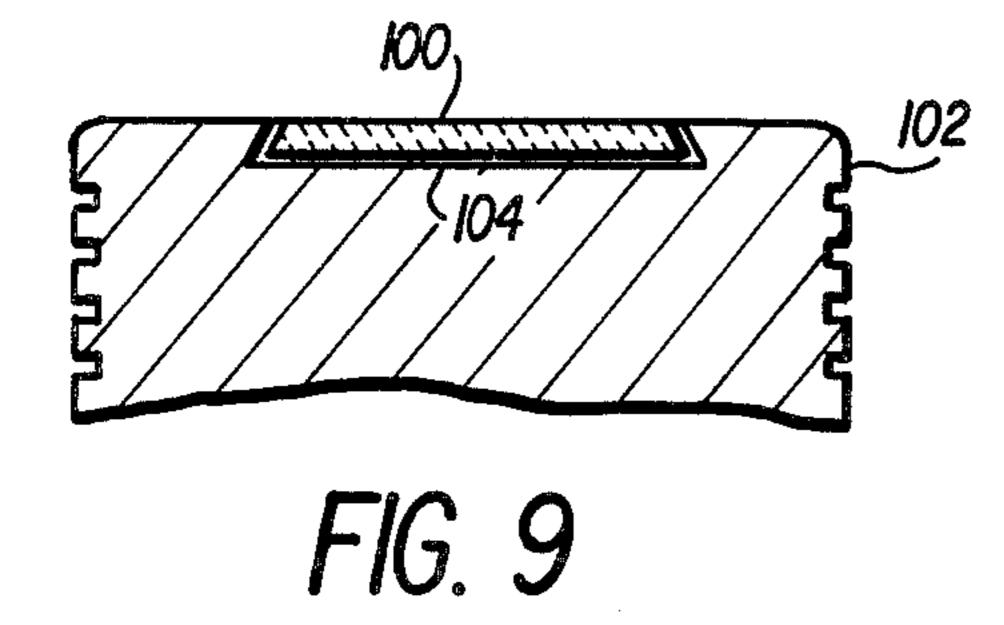
The file of this unexamined application may be inspected and copies thereof may be purchased (849 O.G. 1221, Apr. 9, 1968).

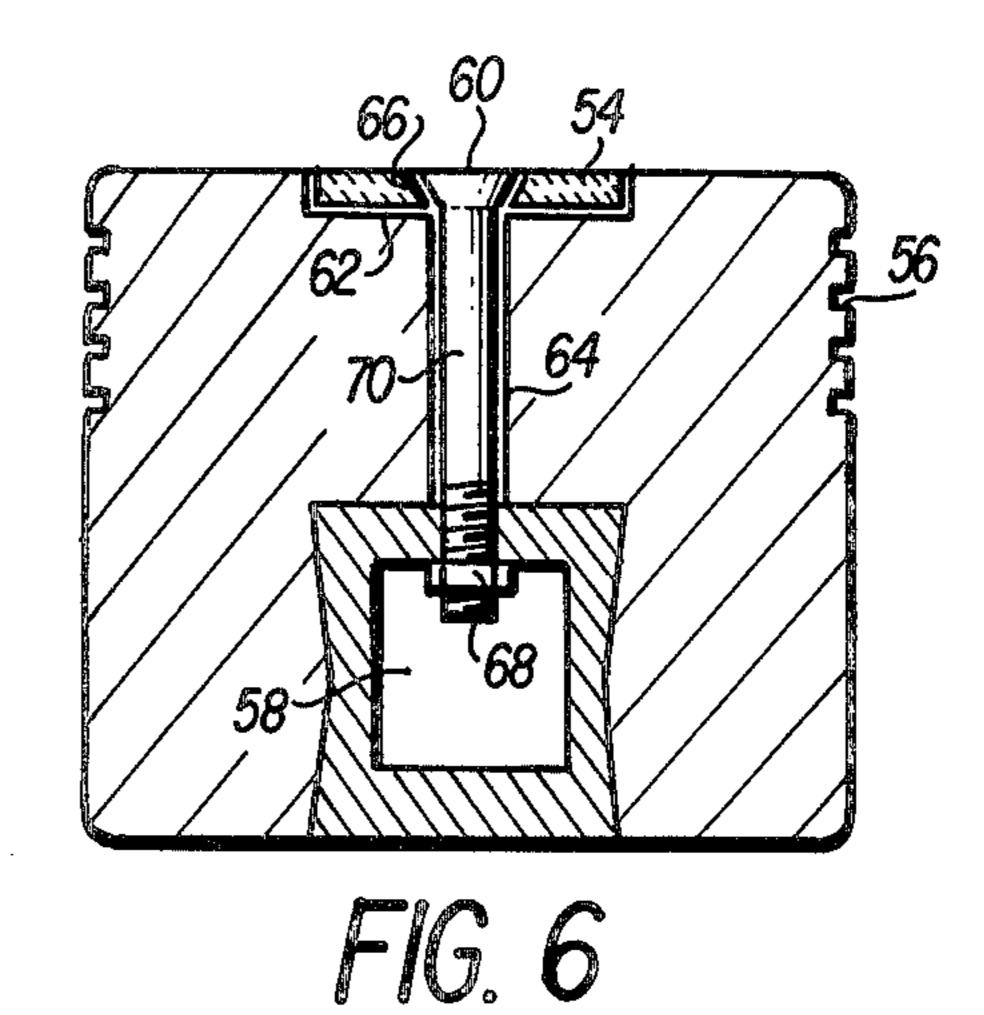


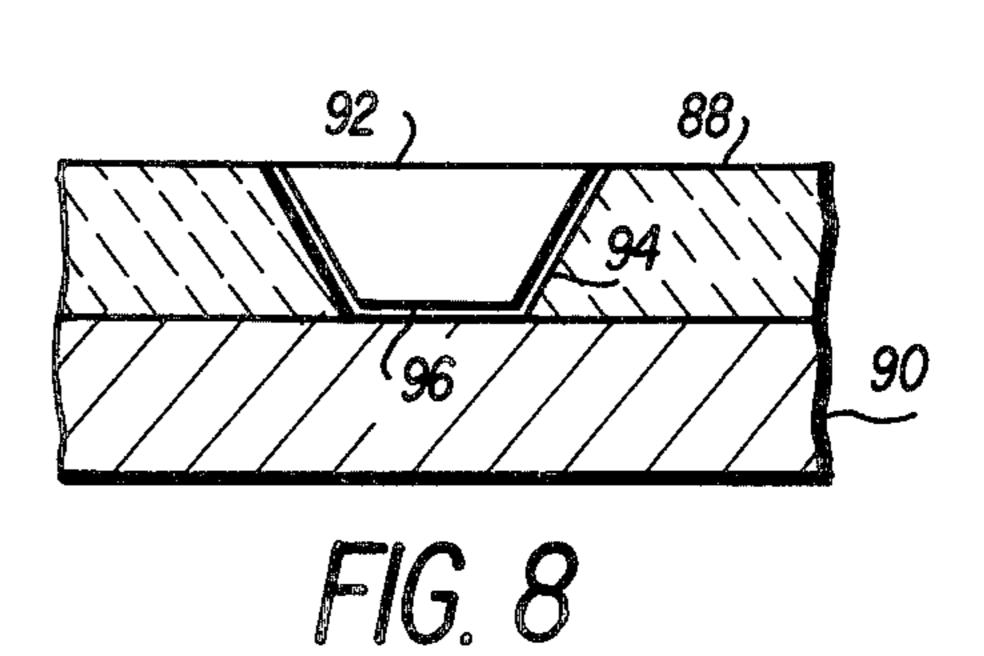


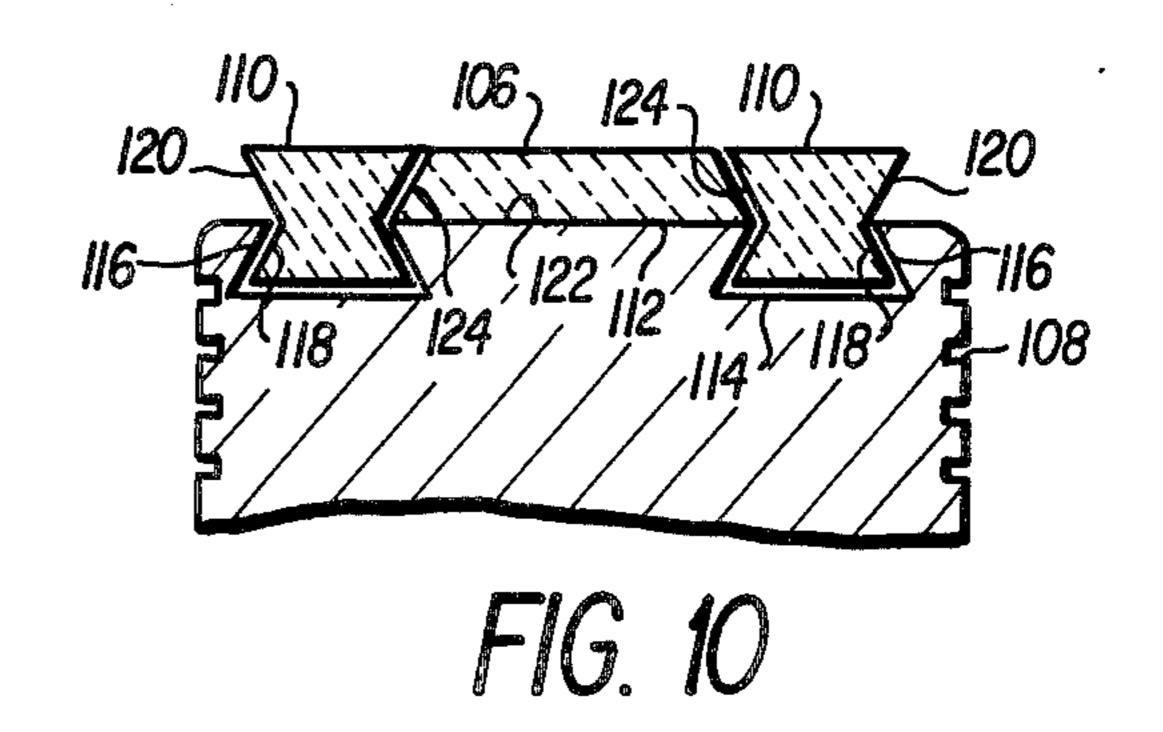












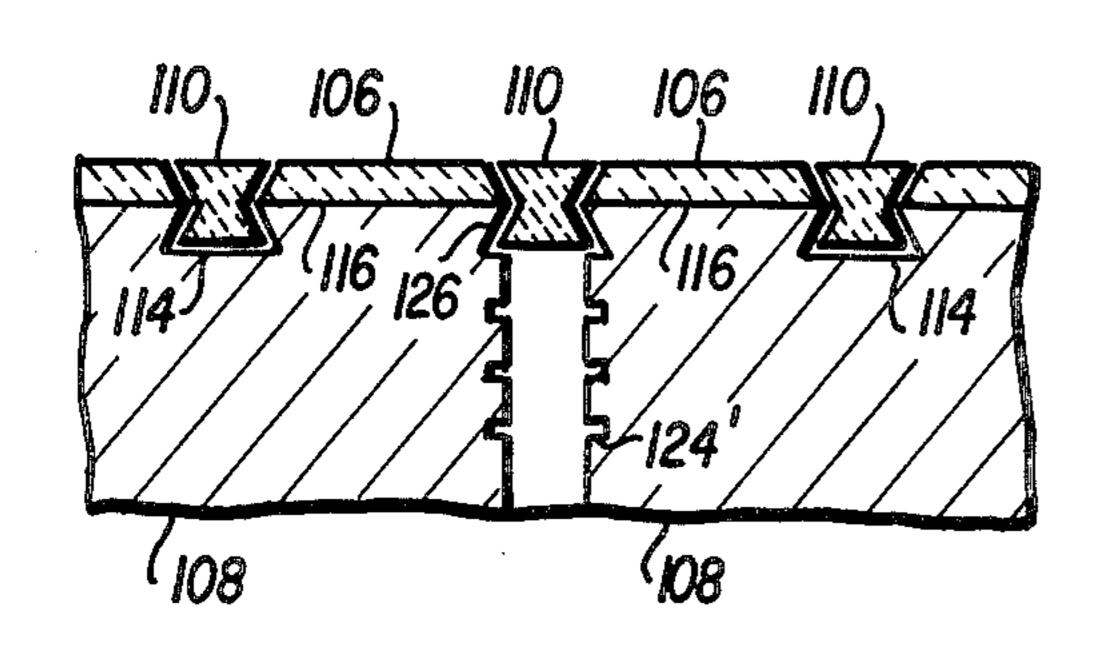


FIG. 14

